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RK3399_Android9.0_软件开发指南

RK3399_Android9.0_Software_Development_Guide

(技术部,第二系统产品部)

(Technical Department, R & D Dept. II)

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前 言 Preface

概述 Overview

本文档主要介绍 Rockchip RK3399 Android9.0 软件开发指南,旨在帮助软件开发工程师更快上手 RK3399 的开发及调试。

This document mainly describes Rockchip RK3399 Android9.0 software development guide aiming to help software engineers familiar with RK3399 development and debugging quickly.

产品版本 Product version

芯片名称	内核版本	Android 版本
Chipset name	kernel version	Android version
RK3399	Linux4.4	Android9.0.0

读者对象 Object

本文档(本指南)主要适用于以下工程师:

This document (guide) is mainly suitable for below engineers:

技术支持工程师

Field application engineers

软件开发工程师

Software development engineers



1 支持列表 Support list

1.1 DDR 支持列表 DDR support list

RK3399 DDR 目前选型列表支持双通道 DDR3、DDR3L、LPDDR3、LPDDR4。

RK3399 DDR current AVL supports dual channel DDR3, DDR3L, LPDDR3, LPDDR4.

Table 1-1 RK3399 DRAM Support Type

Chip	DRAM Support Type
RK3399	DDR3/DDR3L/LPDDR3/LPDDR4

RK3399 DDR 颗粒支持程度列表,详见 RKDocs\common\Platform support lists 目录下《RK DDR Support List Ver2.36》,下表中所标示的 DDR 支持程度表,只建议选用 √、T/A标示的颗粒。

RK3399 DDR component support level refers to $\langle RK DDR Support List Ver2.36 \rangle$ in the directory of RKDocs\common\Platform support lists. Only recommend to use the components marked with the symbol \vee and T/A as shown in below table.

Table 1-2 RK3399 DDR Support Symbol

Symbol	Description
√	Fully Tested and Mass production
T/A	Fully Tested and Applicable
N/A	Not Applicable

1.2 EMMC 支持列表 EMMC support list

RK3399 支持 eMMC 5.1, SDIO3.0, 可运行 HS200, HS400 模式, 详见 RKDocs\comm on\Platform support lists 目录下《RKeMMCSupportList Ver1.41_20181030.pdf》, 下表中所标示的 DDR 支持程度表, 只建议选用 √、T/A 标示的颗粒。

RK3399 supports eMMC 5.1, SDIO3.0, and can run HS200, HS400 mode. For more details, please refer to 《RKeMMCSupportList Ver1.41_20181030.pdf》 in the directory of RKDocs\common\Platform support lists. Only recommend to use the components marked with the symbol \checkmark and T/A as shown in below table.

Table 1-3 RK3399 EMMC Support Symbol

Symbol	Description
√	Fully Tested , Applicable and Mass Production
T/A	Fully Tested , Applicable and Ready for Mass Production

2



Symbol	Description
D/A	Datasheet Applicable, Need Sample to Test
N/A	Not Applicable

1.2.1 高性能 EMMC 颗粒的选取 High performance eMMC component selection

为了提高系统性能,选取高性能的 EMMC 颗粒也是需要的。请在挑选 EMMC 颗粒前,参照我们的支持列表的型号,对应的研究下厂商提供的 Datasheet,重点关注下厂商标注的 performance 一章节。

It is necessary to select high performance EMMC component to improve system performance. Before selecting EMMC component, please refer to our AVL support list, study the corresponding datasheet from vendors, and especially pay attention to the performance chapter.

参照厂商大小、读写的速率进行筛选。建议选取顺序读速率>200Mb/s、顺序写速率>40Mb/s。

Refer to the vendor and read/write rate to do the sorting. Recommend to choose the component with the sequential reading rate >200Mb/s and sequential writing rate >40Mb/s.

如有选型上的疑问,也可直接联系我们的 Fae 窗口。

Contact with our FAE if you have any questions about the component selection.

6.1.5 Performance

[Table 23] Performance

Density	Portition Type	Performance			
Density	Partition Type	Read(MB/s)	Write (MB/s)		
16GB		285	40		
32GB	General	310	70		
64GB	General	310	140		
128GB		310	140		
16GB		295	80		
32GB	Enhanced	320	150		
64GB	Linianced	320	245		
128GB	1	320	245		

图 1-1 EMMC Performance 示例

Picture 1-1 EMMC Performance example

1.3 Wi-Fi/BT 支持列表 Wi-Fi/BT support list

RK3399 内核运行 Linux4.4, Wi-Fi/BT 支持列表,详见 RKDocs\common\Platform support lists 目录下《Rockchip_WiFi_Situation_20180611.pdf》,下表中所标示为目前



RK3399 上大量测试过的 Wi-Fi/BT 芯片列表,建议按照列表上的型号进行选型。如果有其他 Wi-Fi/BT 芯片调试,可先与 Wi-Fi/BT 芯片原厂沟通,是否有可以稳定在 Linux4.4 运行的驱动程序,并能提供调试帮助。

RK3399 kernel is Linux4.4. For the Wi-Fi/BT support list, please refer to « Rockchip_WiFi_Situation_20180611.pdf » in the directory of RKDocs\common\Platform support lists. Below table shows the Wi-Fi/BT chipset list currently already verified in RK3399. Recommend to choose the components in the table. If want to debug other Wi-Fi/BT chipset, first need to communicate with Wi-Fi/BT vendor whether they can provide the driver program which can work on Linux4.4 stably and technical support during debugging.

另外后续我们会不断更新支持列表,如果疑问和建议可以与我们的 Fae 窗口联系。

Besides, we may keep upgrading the support list in future. You can contact with our FAE if there is any question or suggestion.

RK3399 Wi-Fi Situation													
WiFi Chip	IFACE	IEEE 802.11 Standard	2.4GHz Band	5.0GHz Band	ВТ	GPS	NFC	HAC	SDIO3. 0	мімо	BT4.0	BT4.2	Android7.1
AP6330	SDIO	IEEE 802.11A/B/G/N	~	~	~	×	×	×	×	×	✓	×	✓
AP6255	SDIO	IEEE 802.11A/B/G/N/AC	~	~	√	×	×	~	~	×	✓	✓	✓
AP6354	SDIO	IEEE 802.11A/B/G/N/AC	✓	~	√	×	×	~	~	~	✓	×	✓
1. √: 支持 ×: 不支持 注: 空的表示没调过 2. 该列表仅适用kernel4. 4													

图 1-2 RK3399 目前大量测试的 Wi-Fi/BT 支持列表

Picture 1-2 RK3399 currently verified Wi-Fi/BT support list

1.4 SDK 软件包适用硬件列表 SDK software package applicable hardware list

本 SDK 是基于谷歌 Android9.0 64bit 系统,适配瑞芯微 RK3399 芯片的软件包,适用于 laptop 产品形态、Tablet 产品形态、sapphire(蓝宝石)& excavator(挖掘机)开发板、及其 他基于 RK3399 平台开发的产品。

This SDK is compatible with RK3399 chipset software package based on Google Android9.0 64bit system. It is suitable for laptop product, Tablet product, sapphire & excavator development board, and other products developed based on RK3399



platform.

使用的是 sapphire(蓝宝石) & excavator(挖掘机)开发板的,kernel 配置可直接使用 rk3399-sapphire-excavator-edp.dts 进行配置。

If using sapphire & excavator development board, you can use rk3399-sapphire-excavator-edp.dts to config kernel directly.

参考《RK3399_VR&Tablet_V10_20160620》硬件设计(可以通过 FAE 窗口获取)的 TABLET 样机,kernel 配置可以参考:

For TABLET device designed according to 《RK3399_VR&Tablet_V10_20160620》 (which can be acquired from FAE contact), you can configure kernel referring to below:

TABLET:rk3399-mid-818-android.dts

另外随 SDK 发布,附带了 Box 样机板,sapphire(蓝宝石) & excavator(挖掘机)开发板的硬件使用说明。

Besides, along with SDK release, the hardware usage instruction of Box demo board, sapphire & excavator development board is also released.

1.5 多媒体编解码支持列表 Multimedia encoder/decoder support list

RK3399 多媒体方面支持强大,支持 4K VP9 and 4K 10bits H265/H264 视频解码,高达 60fps,1080P 多格式视频解码 (WMV, MPEG-1/2/4, VP8),1080P 视频编码,支持 H.264, VP8 格式,视频后期处理器:反交错、去噪、边缘/细节/色彩优化。

RK3399 has powerful multimedia which supports 4K VP9 and 4K 10bits H265/H264 video decoder up to 60fps, 1080P multi format video decoder (MWV, MPEG-1/2/4, VP8), 1080P video encoder, H.264, VP8 format, video post processor: de-interleaving, de-noising, edge/detail/color optimization.

具体的编解码支持列表,详见 RKDocs\rk3399 目录下《RK3399 Multimedia Codec Ben chmark v1.0》。

For detailed encoder/decoder support list, refer to 《RK3399 Multimedia Codec Benchmark v1.0》 in the directory of RKDocs\rk3399.

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2 文档/工具索引 Document/tool index

2.1 文档索引 Document index

RK3399 SDK 发布文档旨在帮助开发者快速上手开发及调试,文档中涉及的并不能涵盖所有的知识和问题。文档列表也正在不断更新,如有文档上的疑问及需求,请联系我们的 Fae 窗口。

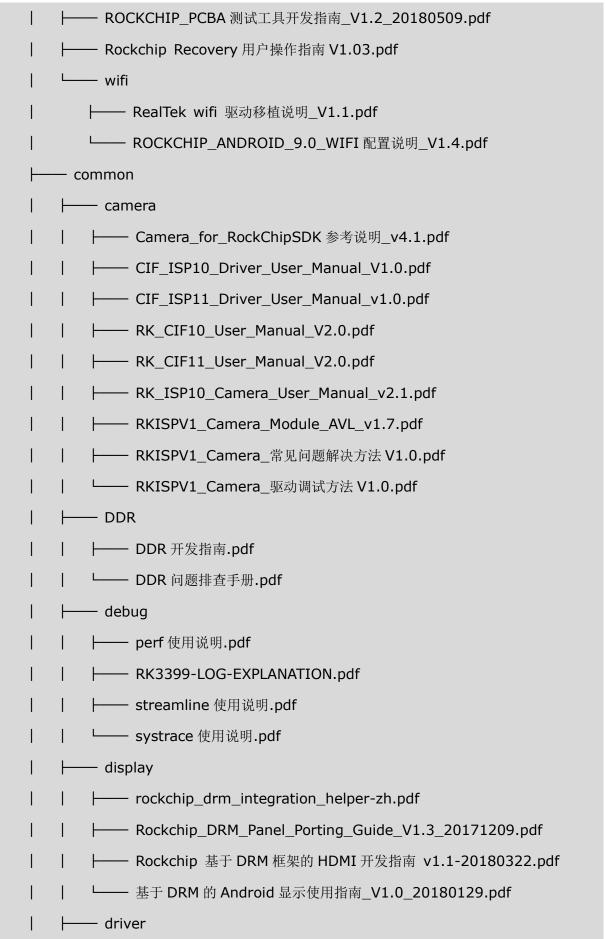
RK3399 SDK release documents aim at helping developers familiar with development and debugging quickly. The documents may not cover all the knowledge and issues and the document list is also being updated continuously. Please contact our FAE if you have any question or requirement about the documents.

RK3399 SDK 中在 RKDocs 目录下附带了三大块的文档,分别为: android (android 相关 开发文档),rk3399(3399 相关发布文档),common(公共开发文档);common 目录细分为 内核驱动开发文档、uboot 开发文档、模块开发文档、Platform support lists(支持列表)、RKTools manuals(工具使用文档)等。

RK3399 SDK includes three kinds of documents in RKDocs directory, android(android related development documents), rk3399(RK3399 related release documents), and common(common development documents). Common directory consists of kernel driver development documents, uboot development document, module development documents, Platform support lists (support list), RKTools manuals (tool usage document) etc.

<u> </u>	— android
1	├── Android_OEM 内容预置功能说明_V1.0_20171122.pdf
1	├── Android_定制开关机动画(铃音)说明_V1.0_20170923.pdf
1	├── Android_性能模式使用说明_V1.0_20170923.pdf
1	├── Android_恢复出厂设置保护功能说明_V1.0_20170923.pdf
1	├── Android_预安装应用功能说明文档_V1.0_20171109.pdf
1	├── Android_验证启动功能说明_V1.0_20171109.pdf
1	├── Android 增加一个分区配置指南 V1.00.pdf
1	project.config
I	├── Rockchip Android 8.1 BOX 显示框架配置说明文档 V1.0-20180210.pdf
I	├── Rockchip Box 媒体中心使用说明-v1.0.1-20170216.pdf





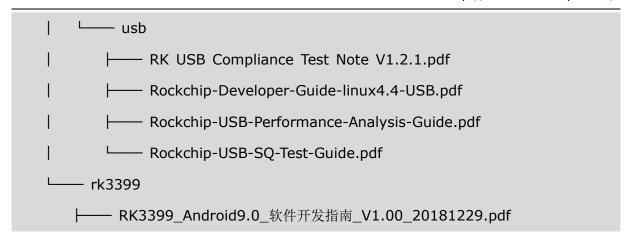


	- 1	1	├── RK 语音通话 3A 算法集成说明及参数调试说明文档_V3.0.pdf
	- 1	1	├── Rockchip Audio 开发指南 V1.1-20170215-linux4.4.pdf
	- 1	1	├── Rockchip CPU-Freq 开发指南 V1.0.1-20170213.pdf
	- 1	1	Rockchip-Developer-Guide-linux4.4-PCIe.pdf
	1	1	Rockchip-Developer-Guide-linux4.4-SDMMC-SDIO-eMMC.pdf
	- 1	1	Rockchip-Developer-Guide-linux4.4-USB.pdf
	1	1	Rockchip-Developer-Guide-MCU.pdf
	- 1	1	Rockchip-Developer-Guide-SPI.pdf
	1	1	Rockchip-Developer-Guide-UART.pdf
	1	1	├── Rockchip DEVFreq 开发指南 V1.0-20160701.pdf
	1	1	├── Rockchip gmac 模块 开发指南 V1.0-20170221.pdf
	1	1	├── Rockchip I2C 开发指南 V1.0-20160629.pdf
	- 1	1	├── Rockchip IO-Domain 开发指南 V1.0-20160630.pdf
	1	1	├── Rockchip Pin-Ctrl 开发指南 V1.0-20160725.pdf
	- 1	1	├── Rockchip pwm ir 开发指南 V1.00.pdf
	- 1	1	├── Rockchip pwm 背光 开发指南-20170220.pdf
	l	1	├── Rockchip RK805 开发指南 V1.0-20170217.pdf
	1	1	├── Rockchip RK816 开发指南 V1.pdf
│	1	1	├── Rockchip RK818_6 电量计 开发指南 V2.0-20170525mo.pdf
│	1	1	├── Rockchip RK818 电量计 开发指南 V1.0-20160725.pdf
	l	1	├── Rockchip Thermal 开发指南 V1.0.1-20170428.pdf
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	1	1	└── Rockchip 电源 独立 DCDC 开发指南 V1.0-20170519.pdf
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│ │	l	1	├── 3G 数据卡 USB 切换文件制作说明_v1.2.pdf
	Ι	I	L—— ROCKCHIP_3G_DONGLE_配置说明_V1.0.pdf
Platform support lists	Ι	-	— Platform support lists
RK3128 BOX Hardware Design Guide V10-201410.pdf	1	I	RK3128 BOX Hardware Design Guide V10-201410.pdf



I	- 1	<u> </u>	RK DDR Support List Ver2.29.pdf
- 1	1		RKeMMCSupportList Ver1.38_2018_01_22.pdf
I	1	├──	RKISPV11_Camera_Module_AVL_v1.5.pdf
I	1	├──	RKISPV1_Camera_Module_AVL_v1.7.pdf
1	1	├──	RKNandFlashSupportList Ver2.72_2016_08_30.pdf
1	1	├──	Rockchip Kodi 支持程度列表_V2.0_20170715.pdf
	1	L	Rockchip_WiFi_Situation_20180403.pdf
	—	— RKTo	pols manuals
	1	├	Android 开发工具手册.pdf
- 1	1	<u> </u>	REPO 镜像服务器搭建和管理_V2.2_20131231.pdf
	1	<u> </u>	RKUpgrade_DII_UserManual.pdf
- 1	1	<u> </u>	RK 平台 apache_tomcat_ota 服务器搭建说明.rar
	1	<u> </u>	rk 平台量产升级指导文档 V1.1.pdf
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- 1	1		Rockchip Keybox Burning Guide V1.2-20180315.pdf
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I	- 1		Rockchip 量产烧录 指南 V1.1-20170214.pdf
- 1	1	<u> </u>	WNpctool 写号工具简要使用说明_V1.1.2.pdf
I	- 1	 .	压力测试 Stresstest 文档 forVR_ver3.0.pdf
- 1	- 1	 	瑞芯微 Attestation_Keybox 烧录指南_V1.0_20180320.pdf
I	- 1		瑞芯微 Keybox 烧录指南_V1.2_20180319.pdf
	1	<u> </u>	量产工具升级及相关问题处理.pdf
1	-	secu	rity
		⊢—	Rockchip_Secure_Boot_Application_Note_V1.2.1_20171128.pdf
	-	L	Rockchip_TEE 安全 SDK 开发手册_V1.1_20170516.pdf
	H	— u-bo	oot
			Rockchip-Developer-Guide-Trust.pdf
		L	Rockchip U-Boot 开发指南 V3.8-20170214.pdf
			u





2.2 工具索引 Tool index

RK3399 SDK 发布的工具,用于开发调试阶段及量产阶段使用。工具可能随 SDK 更新不断更新,如有工具上的疑问及需求,请联系我们的 Fae 窗口。

RK3399 SDK released tool is used in development debugging stage and MP stage. The tool may upgrade along with new SDK. Please contact with our FAE if there is any question or requirement about the tool.

RK3399 SDK 中在 RKTools 目录下附带了 linux(Linux 操作系统环境下使用工具)、windows (Windows 操作系统环境下使用工具)。

RK3399 SDK contains linux (tool used in Linux operation system environment) and windows (tool used in Windows operation system environment) in RKTools directory.





├── OemTool_v1.3.rar (Demo 镜像制作工具)
├── SDDiskTool_v1.56.zip (SD 卡升级固件制作工具)
├── SecureBootTool_v1.85_foruser.rar (固件签名工具)
├── SpiImageTools_v1.41.zip
└── UpgradeDllTool_v1.35.zip (厂商信息烧写工具一待更新版本)



3 SDK 编译/烧写 SDK compiling/flashing

3.1 SDK 获取 Acquire SDK

SDK 通过瑞芯微代码服务器对外发布。客户向瑞芯微技术窗口申请 SDK,需同步提供 SSH 公钥进行服务器认证授权,获得授权后即可同步代码。关于瑞芯微代码服务器 SSH 公钥授权,请参考《RK3399_Android9.0-SDK_发布说明 V1.00_20181209.pdf》。

SDK is released through Rockchip code server. Customers apply SDK from Rockchip FAE contact, and will be able to sync code after obtaining the server certificate authorization with SSH public key. For more details about Rockchip code server SSH public key authorization, please refer to 《 RK3399_Android9.0-SDK_ 发 布 说 明 V1.00_20181209.pdf》.

3.1.1 SDK 下载链接 SDK download link

RK3399 ANDROID9.0 SDK 下载地址如下:

RK3399_ANDROID9.0-SDK download address is as below:

repo init --repo-url=ssh://git@www.rockchip.com.cn:2222/repo-release/tools/re
po.git -u ssh://git@www.rockchip.com.cn:2222/Android_pie_stable/platform/rk339
9/manifests.git -m RK3399_Android_Pie_release.xml

3.1.2 repo

repo 是 google 用 Python 脚本写的调用 git 的一个脚本,主要是用来下载、管理 Android 项目的软件仓库,其下载地址如下:

repo is a script invoking git developed by Google using Python script, and mainly used to download, manage Android project software lib. The download address is as below:

git clone ssh://git@www.rockchip.com.cn/repo/rk/tools/repo

3.1.3 SDK 代码压缩包 SDK code compressed package

为方便客户快速获取 SDK 源码,瑞芯微技术窗口通常会提供对应版本的 SDK 初始压缩包,开发者可以通过这种方式,获得 SDK 代码的初始压缩包,该压缩包解压得到的源码,与通过 repo 下载的源码是一致的。以 rk3399_Android_Pie_release_20190104.tar.gz 为例,拷贝到该初始化包后,通过如下命令可检出源码:

Rockchip FAE contact usually will provide the initial compressed package of the



corresponding version SDK in order to help customers acquire SDK source code quickly. Developer can acquire the initial compressed package of SDK code in this way and unzip it to get the source code. It is the same as the source code downloaded through repo. Take rk3399_Android_Pie_release_20190104.tar.gz as an example, you can sync the source code through below command after copy the initial package:

tar zxvf rk3399_Android_Pie_release_20190104.tar.gz -C rk3399

.repo/repo/repo sync -l

mkdir rk3399

cd rk3399

.repo/repo/repo sync

后续开发者可根据 Fae 窗口定期发布的更新说明,通过".repo/repo/repo sync"命令同步更新。

Developers can execute the command ".repo/repo/repo sync" to sync the new code according to the update notice released by FAE contact periodically in future.

3.2 SDK 编译 SDK compiling

3.2.1 JDK 安装 JDK installation

Android9.0 系统编译依赖于 JAVA 8。编译之前需安装 OpenJDK。

Android9.0 system compiling is dependent on JAVA 8. Need to install OpenJDK before compiling.

安装命令如下:

Install command is as below:

sudo apt-get install openjdk-8-jdk

配置 JAVA 环境变量,例如,安装路径为/usr/lib/jvm/java-8-openjdk-amd64,可在终端执行如下命令配置环境变量:

Configure JAVA environment variable, for example, if the install path is /usr/lib/jvm/java-8-openjdk-amd64, it is able to execute below command to configure environment variable at the terminal:

export JAVA_HOME=/usr/lib/jvm/java-8-openjdk-amd64

export PATH=\$JAVA_HOME/bin:\$PATH

export CLASSPATH=::\$JAVA_HOME/lib:\$JAVA_HOME/lib/tools.jar



SDK 带有 Open JDK8 的配置脚本,在工程根目录下,命名为 javaenv.sh。

SDK contains Open JDK8 configuration script named javaenv.sh in project root directory.

可直接执行以下命令,配置 JDK:

Directly execute below command to configure JDK:

source javaenv.sh

3.2.2 编译模式 Compilation mode

SDK 默认以 userdebug 模式编译。

SDK default compiling mode is userdebug.

使用 adb 时,需要先执行 adb root ,adb disable-verity 关闭 system 分区的 verity 特性,重启后再执行 adb root, adb remount,进而进行 push 操作来 debug。

While using adb, first need to execute adb root, adb disable-verity to close the verity feature of the system partition, then execute adb root, adb remount after reboot, and then execute push operation to debug.

3.2.3 挖掘机编译 Excavator compilation

uboot 编译:

uboot compiling:

cd u-boot

make clean

make mrproper

./make.sh rk3399 适用于 RK3399 芯片 suitable for RK3399

kernel 编译:

kernel compiling:

cd kernel

make ARCH=arm64 rockchip_defconfig -j8

make ARCH=arm64 rk3399-sapphire-excavator-edp-avb.img -j12

android 编译:

Android compiling:

source build/envsetup.sh

lunch rk3399-userdebug

make -j12



./mkimage.sh

3.2.4 mid 相关产品编译 MID related product compiling

uboot 编译:

uboot compiling:

cd u-boot make clean make mrproper

./make.sh rk3399 适用于 RK3399 芯片 suitable for RK3399

kernel 编译:

kernel compiling

cd kernel

make ARCH=arm64 rockchip_defconfig -j8

make ARCH=arm64 rk3399-tve1030g-avb.img -j12

android 编译:

android compiling

source build/envsetup.sh

lunch rk3399_mid-userdebug

make -j12

./mkimage.sh

注: android9.0 的工程 debug 阶段,要使修改的 kernel 生效,如果未开启 AVB 特性(见6.1章节),则只需要重新编译内核并执行./mkimage.sh,烧写固件输出目录rockdev/Image-xxx下的 boot.img;若开启 AVB 特性,需要重新编译整个固件,即内核编译之后,需要重新对 android 进行编译打包:make installclean && make -j12 && ./mkimage.sh,然后烧写固件输出目录rockdev/Image-xxx下的 boot.img。

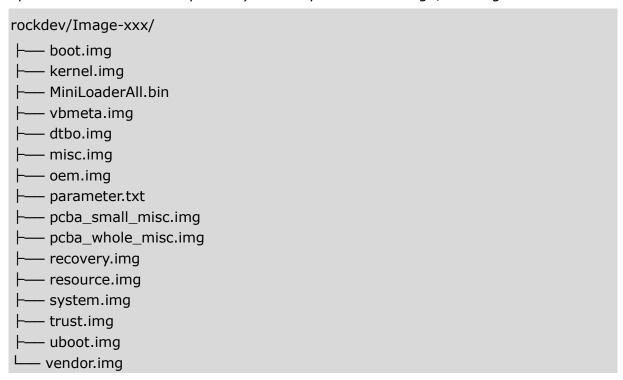
Note: To make kernel modification valid in android9.0 project debug stage, if AVB feature is not enabled (refer to section 6.1), only need to re-compile kernel and execute ./mkimage.sh, flash boot.img in the image output directory of rockdev/Image-xxx. If AVB feature is enabled, need to re-compile the whole image, that is, after kernel compiling, need to compile and package android again: make installclean && make -j12 && ./mkimage.sh, and then flash boot.img in the image output directory of rockdev/Image-xxx.



3.2.5 固件生成步骤 Image build steps

执行./mkimage.sh 后,在 rockdev/Image-xxx/目录生成完整的固件包(xxx 是具体 lunch 的产品名)

The complete images package will be generated in rockdev/Image-xxx/ (xxx is the specific name of lunched product) directory after executing ./mkimage.sh.



得到所有镜像文件后,为了方便烧写及量产,通常可手动将这些单独的镜像通过脚本打包成为 update.img。

After acquiring all the mirror files, usually you can manually use the script to package them as update.img which is convenient for flashing and MP.

3.2.6 全自动编译脚本 Fully automatic compiling script

如前几节所述,编译可大致分为 u-boot、kernel、android 三大部分进行编译,为了提高编译的效率,降低人工编译可能出现的误操作,该 SDK 中集成了全自动化编译脚本,方便固件编译、备份。

As described above, the compilation mainly contains three parts compiling u-boot, kernel and android. In order to improve the compiling efficiency and lower down the possible mistake operation of manual compiling, this SDK integrates the fully automatic compiling script which is convenient for image compiling and backup.

1) 该全自动化编译脚本原始文件存放于:



The original file of the fully automatic compiling script is put in:

device/rockchip/RK3399/build.sh

2) 在 repo sync 的时候,通过 manifest 中的 copy 选项拷贝至工程根目录下:

When repo sync, copy it to the project root directory through manifest:

<copyfile src="buildspec.mk" dest="buildspec.mk"/>

<copyfile src="build.sh" dest="build.sh"/>

</project>

3) 修改 build.sh 脚本中的特定变量以编出对应产品固件。

Modify the specific variable in build.sh script to build out the corresponding product images.

KERNEL_DTS=rk3399-sapphire-excavator-edp-avb

变量请按实际项目情况,对应修改:

Modify the variable according to the actual project situation:

KERNEL_DTS 变量指定编译 kernel 的产品板极配置;

KERNEL_DTS variable specifies the product board level configuration for kernel compiling.

Android 编译需要指定对应的 lunch 选项,请在执行 build.sh 之前执行 lunch 操作,确保使用了正确的 lunch 选项,例如:

Android compiling needs to specify the corresponding lunch option. Please execute lunch operation before executing build.sh. Make sure the correct lunch option is used. For example:

lunch rk3399_mid-user

4) 执行自动编译脚本:

Execute automatic compiling script:

该脚本会自动配置 JDK 环境变量,编译 u-boot,编译 kernel,编译 Android,继而生成固件和版本信息,并打包成 update.img。

The script will automatically configure JDK environment variable, compile u-boot,



compile kernel, compile Android, then generate images and version information, and package them to be update.img.

5) 脚本生成内容:

The script generated contents:

脚本会将编译生成的固件拷贝至:

The script will copy the compiled images to:

IMAGE/RK3399 *****_RELEASE_TEST/IMAGES 目录下,具体路径以实际生成为准。每次编译都会新建目录保存,自动备份调试开发过程的固件版本,并存放固件版本的各类信息。建议在每次大版本编译的时候,使用这个编译脚本生成固件,里面包含了很多的版本信息,便于追查问题的时候定位代码的状态。

the directory of IMAGE/RK3399 *****_RELEASE_TEST/IMAGES which path is subject to the actual generation. Each compiling will create new directory and save, automatically backup images version during debugging, and keep all the information of images version. Recommend to use this compiling script to generate images for every big version compilation. It includes much version information which is convenient to locate code status while debugging issues.

该目录下的 update.img 可直接用于 Android 开发工具及工厂烧写工具下载更新。

update.img in the directory can be directly used to download and update Android development tool and factory flashing tool.

3.3 固件烧写 Image flashing

刷机说明详见 RKDocs\common\RKTools manuals 目录下《Android 开发工具手册.pdf》。 SDK 提供烧写工具,如下图所示。编译生成相应的固件后,进入烧写模式,即可进行刷机。对于已 烧过其它固件的机器,可以选择重新烧录固件,或是选择低格设备,擦除 idb,然后进行刷机。

Flashing instruction refers to 《Android 开发工具手册.pdf》 in the directory of RKDocs\common\RKTools manuals. SDK provides flashing tools as shown in below picture. After compiling to generate corresponding images, enter flashing mode, it is able to flash images. For the devices with existing images, you can select to re-flash images, or format the device, erase idb, and then flash the images.



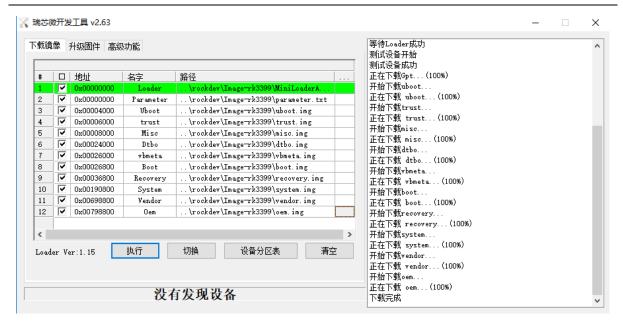


图 3-1 Android 开发工具烧写界面

Picture 3-1 Android development tool flashing interface

注: Note:

1) 烧写前,需安装最新的 USB 驱动,驱动详见:

Need to install the latest USB driver before flashing. The driver refers to:

```
RKTools/windows/

—— DriverAssitant_v4.5.zip
```

2) Android9.0 相比 Android8.1 多了 Dtbo.img 和 vbmeta.img,固件烧写的时候必须烧写这两个 img,否则系统无法开机。

Comparing with Android8.1, Android9.0 has two more images Dtbo.img and vbmeta.img. These two img must be flashed, otherwise the system will fail to boot up.

3.4 量产烧写 MP flashing

量产上考虑到生产效率及工厂工位安排,量产烧写说明详见 RKDocs\ common\RKTools manuals 目录下《Rockchip 量产烧录指南 V1.1-20170214.pdf》。

Considering the production efficiency and factory work station arrangement during MP, the flashing instruction refers to《Rockchip 量产烧录指南 V1.1-20170214.pdf》in the directory of RKDocs\ common\RKTools manuals.

在量产过程中如涉及到工具上的问题,可以联系我们的 Fae 窗口。

Please contact with our FAE if you have any tool related issues during production.



4 U-Boot 开发 U-Boot development

U-Boot 基本概念、编译的注意事项和 RK 平台 U-Boot 框架等具体的开发细节可参考 RKDocs\common\u-boot 目录下《Rockchip-Developer-Guide-UBoot-nextdev.pdf》。

U-Boot basic concept, compilation notices and the specific development details of RK platforms U-Boot framework can refer to 《Rockchip-Developer-Guide-UBoot -nextdev.pdf》 in the directory of RKDocs\common\u-boot.

5 Kernel 开发 Kernel development

本节简单介绍内核一些常见配置的修改,主要是 dts 的配置,帮助客户更快更方便的进行一些简单的修改。RK3399 kernel 版本是 4.4, config 配置文件统一为 arch/arm64/configs/rockchip_defconfig,RK3399 的串口波特率为 1500000,调试时请保证设置准确。

This chapter simply introduces some kernel common configurations changes, mainly for dts configuration, to help customers to do some simple changes faster and more convenient. RK3399 kernel version is 4.4 and config files are unified as arch/arm64/configs/ rockchip_defconfig. RK3399 serial port baud rate is 1500000. Please make sure the setting correct for debugging.

5.1 DTS 介绍 DTS introduction

5.1.1 DTS 说明 DTS introduction

RK3399 的 dts 文件在 kernel/arch/arm64/boot/dts/rockchip/下,其中 rk3399.dtsi 是核心配置文件定义了平台相关的内容; RK3399-android.dtsi 是产品级配置文件定义了一些外围设备; 具体的产品 dts 需要 include 这两个文件,如 Tablet 产品的 dts 文件 rk3399-mid-818-android.dts。产品的 dts 里面根据具体的产品需求配置 CPU、GPU、DDR 的频率和电压表;配置 io、屏、wifi、bt、sensor、温控、背光、电池、系统供电配置等等。

RK3399 dts file is in kernel/arch/arm64/boot/dts/rockchip/. Rk3399.dtsi is the core configuration file which defines the platform related contents. RK3399-android.dtsi is the product level configuration file which defines some peripheral devices. The specific product dts needs to include these two files, e.g. Tablet product dts file



rk3399-mid-818-android.dts. Configure CPU, GPU, DDR frequency and voltage table in product dts according to the specific product requirement. Configure io, panel, wifi, bt, sensor, thermal control, backlight, battery, system power configuration etc.

挖掘机采用 rk3399-sapphire-excavator-edp-avb.dts 这个文件。

Excavator uses the file rk3399-sapphire-excavator-edp-avb.dts.

5.1.2 新增一个产品 DTS Create a new product DTS

Rk3399 的产品 dts 文件需放在 kernel/arch/arm64/boot/dts/rockchip/下。

RK3399 product dts file should be put in kernel/arch/arm64/boot/dts/rockchip/.

1、以 rk3399-sapphire-excavator-edp-avb.dts 或 rk3399-tve1030g-avb.dts 为参照, 拷贝一份 dts 文件命名为 rk3399-product-avb.dts。

Take rk3399-sapphire-excavator-edp-avb.dts or rk3399-tve1030g-avb.dts as reference, copy a dts file and name it as rk3399-product-avb.dts.

2、修改 arch/arm64/boot/dts/rockchip/Makefile 文件,添加对应 dtb 声明:

Modify arch/arm64/boot/dts/rockchip/Makefile file, add the corresponding dtb statement:

+rk3399-product-avb.dtb

3、修改编译脚本或编译命令。

Modify the compiling script or command.

4、重新编译内核。

Re-compile kernel.

5.2 USB 配置 USB configuration

RK3399 Type-c 模块需要外挂一个 fusb302 逻辑检测芯片来识别接入设备类型及 USB 的正反插。Fusb302 的软件驱动在 dts 里面的配置如下:

RK3399 Type-c module needs to add an external fusb302 logic detection chipset to identify the connected device type and USB plug and reverse. The configuration of fusb302 software driver in dts is as below:

```
fusb0: fusb30x@22 {  compatible = "fairchild,fusb302"; \\ reg = <0x22>; \\ pinctrl-names = "default";
```



```
pinctrl-0 = <&fusb0_int>;
int-n-gpios = <&gpio1 1 GPIO_ACTIVE_HIGH>;
status = "okay";
};
中断脚配置:
The configuration of interrupt pin:
&pinctrl {
fusb30x {
    fusb0_int: fusb0-int {
        rockchip,pins = <1 2 RK_FUNC_GPIO &pcfg_pull_up>;
        };
};
```

在 fusb302 及 usb phy 检测区分接入 type-c 口的是哪一类设备(充电器、USB、OTG、DP等)之后,通知系统,相关联的模块代码需要注册 fusb302 的 extcon notifier 来接收,需要在模块 dts 配置加入 extcon = <&fusb0>。

After fusb302 and usb phy identify the device type (charger, USB, OTG, DP etc.) connected to the type-c, it will inform the system, so related module code needs to register extcon notifier of fusb302 to receive, need to add extcon = <&fusb0> in the dts configuration of module.

如 rk818 dts 节点中加入 extcon = <&fusb0>,通过 fusb302 及 usb phy 检测区分充电器、USB、OTG 的拔插后, rk818 模块决定相关的充电电流配置及 OTG 的开关。

For example, add extcon = <&fusb0> in rk818 dts node, after fusb302 and usb phy detect and identify the plug/unplug of charger, USB, OTG, rk818 module decides relative charging current configuration and OTG switch.

目前 sdk 参考 dts 中默认 enable 了 fusb302 的配置,如果产品未使用 type-c 接口、未使用 fusb302,产品 dts 中请 disabled 节点 tcphy0 及 fusb0,并将 USB 相关联的模块 dts 中 extcon = <&fusb0>改为 extcon = <&u2phy0>。

Currently fusb302 configuration is enabled by default in sdk reference dts, if product doesn't use type-c interface and fusb302, please disable the node tcphy0 and



fusb0 in product dts, and change extcon = <&fusb0> to extcon = <&u2phy0> in the dts of USB related module.

5.3 Wi-Fi 配置 Wi-Fi configuration

```
wireless-wlan {
    compatible = "wlan-platdata";
    rockchip,grf = <&grf>;
    wifi_chip_type = "ap6354";
    sdio_vref = <1800>;
    WIFI,host_wake_irq = <&gpio0 3 GPIO_ACTIVE_HIGH>; /* GPIO0_a3 */
    status = "okay";
};/
```

上面部分内容是 Wi-Fi 的 dts 配置内容,主要包括电源控制、中断等功能脚的配置。下面将对各个配置项(一般客户只需要修改下面红色标出部分参数)的功能进行详细描述:

The above is the content of Wi-Fi dts configuration, mainly including the configuration of power control, interrupt and other function pins. The configuration items (generally customers only need to modify the parameters marked in red) function will be explained as below:

```
wifi_chip_type = " ap6354";
```

用来确认 Wi-Fi 芯片型号,实际使用什么型号的 Wi-Fi 需要在这里指定:

Use to check Wi-Fi chipset. Need to specify the actually used Wi-Fi model here:

```
sdio_vref = <1800>; //1800mv or 3300mv
```

这个配置项配置 Wi-Fi 模组的 IO 参考电压值,根据实际硬件设计中提供给 Wi-Fi 模组参考电压输入的电压值来进行设定,参考电压设置错误会导致 Wi-Fi 通信异常,引起 Wi-Fi 打不开或者工作不稳定。

This item configures IO reference voltage value of Wi-Fi module, set the input voltage value according to the Wi-Fi module reference voltage provided by the actual hardware design. The reference voltage set improperly will cause Wi-Fi communication abnormal, and then lead to Wi-Fi fail to work or work unstably.

```
WIFI,host_wake_irq = <&gpio0 3 GPIO_ACTIVE_HIGH>;
```

这个配置项是 Wi-Fi 中断脚的配置,某些 Wi-Fi 模组没有这个脚可以不用配置直接将此配置项



注释掉。使用 Broadcom 的 Wi-Fi, 比如 AP6xxx 以及 RK90x 等模组都需要正确配置这 GPIO。

This item configures Wi-Fi interrupt pin. If some Wi-Fi module doesn't have this pin, directly comment it out without configuration. Broadcom Wi-Fi such as AP6xxx and RK90x etc. modules all need to configure this GPIO correctly.

Broadcom wifi AP6xxx 系统会使用此中断脚作为 Wi-Fi 数据中断脚,此中断脚有异常将会导致 Wi-Fi 无法正常工作。其它 Wi-Fi,例如 RTL8723BS,在机器进入休眠时,如果有 Wi-Fi 数据到来时此中断用来唤醒机器。此中断脚有异常并不会造成 Wi-Fi 无法正常工作。

For Boardcom wifi AP6xxx system uses this interrupt pin as Wi-Fi data interrupt pin and Wi-Fi cannot work normally if there is problem with the interrupt pin. For other Wi-Fi, such as RTL8723BS, when the device is in sleep mode, the interrupt is used to wake up the device if there is Wi-Fi data coming. So the problem of the interrupt pin will not cause that Wi-Fi cannot work normally.

5.4 BT 配置 BT configuration

```
wireless-bluetooth {
    compatible = "bluetooth-platdata";
    //wifi-bt-power-toggle;
    uart_rts_gpios = <&gpio2 19 GPIO_ACTIVE_LOW>; /* GPIO2_C3 */
    pinctrl-names = "default", "rts_gpio";
    pinctrl-0 = <&uart0_rts>;
    pinctrl-1 = <&uart0_gpios>;
    //BT,power_gpio = <&gpio3 19 GPIO_ACTIVE_HIGH>; /* GPIOx_xx */
    BT,reset_gpio = <&gpio0 9 GPIO_ACTIVE_HIGH>; /* GPIO0_B1 */
    BT,wake_gpio = <&gpio2 26 GPIO_ACTIVE_HIGH>; /* GPIO2_D2 */
    BT,wake_host_irq = <&gpio0 4 GPIO_ACTIVE_HIGH>; /* GPIO0_A4 */
    status = "okay";
};
```

以上是BT在dts里面的配置,下面对常见可能需要修改的部分进行简单的说明:

Above is the BT configuration in dts. Simply introduce some common parts that may need to be modified as below:

```
BT,reset_gpio = <&gpio0 9 GPIO_ACTIVE_HIGH>;
```



这个配置项是关于 BT 的 RESET 脚配置,这个脚不同的 BT 模组不一定都有,具体以实际原理图为准。

This configuration item is about BT RESET pin configuration. Not all BT modules have this pin. Refer to the actual schematic.

BT,power_gpio = <&gpio3 19 GPIO_ACTIVE_HIGH>

这个配置项是关于 BT 的电源控制 GPIO 配置,高电平有效,具体以实际原理图为准。

This configuration item is about BT power control GPIO configuration, high level active, refer to the actual schematic.

BT,wake_gpio = <&gpio2 26 GPIO_ACTIVE_HIGH>;

这个配置项是关于 BT 的 WAKE 脚配置, 对应原理图中的 BT_WAKE 管脚,高电平有效。

This configuration item is about BT WAKE pin configuration, corresponding to BT_WAKE pin in the schematic, high level active.

BT,wake_host_irq = <&gpio0 4 GPIO_ACTIVE_HIGH>

这个配置项是关于 BT 的中断脚配置,对应原理图中的 BT_HOST_WAKE 管脚,高电平有效。

This configuration item is about BT interrupt configuration, corresponding to BT HOST WAKE pin in the schematic, high level active.

默认 BT 使用 uart0 接口连接, uart0 的配置如下:

BT uses uart0 interface to connect by default. Uart0 configuration is as below:

```
pinctrl-names = "default";
pinctrl-0 = <&uart0_xfer &uart0_cts>;
```

status = "okay";

};

&uart0 {

5.5 GPIO

RK3399 提供 5 组 GPIO(GPIO0~GPIO4)共 122 个,所有的 GPIO 都可以用作中断,GPIO0/GPIO1 可以作为系统唤醒脚,所有 GPIO 都可以软件配置为上拉或者下拉,所有 GPIO 默认为输入,GPIO 的驱动能力软件可以配置。

RK3399 provides 5 groups GPIO(GPIO0~GPIO4) total 122pcs. All GPIO can be used as interrupt. GPIO0/GPIO1 can be used as system wakeup pin. All GPIO can be pulled up or down by software configuration. All GPIO by default is input and the driver



ability can be configured by software.

关于原理图上的 gpio 跟 dts 里面的 gpio 的对应关系,例如 GPIO4c0,那么对应的 dts 里面应该是"gpio4 16"。因为 GPIO4A 有 8 个 pin,GPIO4B 也有 8 个 pin,以此计算可得 c0 口就是 16,c1 口就是 17,以此类推;

As for the gpio corresponding relationship between schematic and dts, such as GPIO4c0, the corresponding gpio in dts should be "gpio4 16". As GPIO4A has 8 pins, GPIO4B also has 8 pins, inferring in this way, we can know c0 port is 16, c1 port is 17, and so on.

GPIO 的使用请参考 RKDocs\common\driver\目录下《Rockchip Pin-Ctrl 开发指南 V1.0-20160725.pdf》。

GPIO usage refers to 《Rockchip Pin-Ctrl 开发指南 V1.0-20160725.pdf》 in the directory of RKDocs\common\driver\.

5.6 ARM、GPU、DDR 频率修改 ARM, GPU, DDR frequency change

DVFS (Dynamic Voltage and Frequency Scaling) 动态电压频率调节,是一种实时的电压和频率调节技术。目前 4.4 内核中支持 DVFS 的模块有 CPU、GPU、DDR。

DVFS (Dynamic Voltage and Frequency Scaling) is a real-time voltage and frequency adjusting technology. Currently in kernel 4.4 CPU, GPU, DDR modules support DVFS.

CPUFreq 是内核开发者定义的一套支持动态调整 CPU 频率和电压的框架模型。它能有效的降低 CPU 的功耗,同时兼顾 CPU 的性能。

CPUFreq is a set of framework model supporting dynamically adjusting CPU frequency and voltage defined by kernel developers. It can effectively lower down CPU power consumption and balance CPU performance at the same time.

CPUFreq 通过不同的变频策略,选择一个合适的频率供 CPU 使用,目前的内核版本提供了以下几种策略:

CPUFreq selects a suitable frequency for CPU through different frequency scaling strategies. Current kernel version provides below strategies:

- interactive: 根据 CPU 负载动态调频调压;
 interactive: dynamically adjust frequency and voltage according to CPU load.
- conservative: 保守策略,逐级调整频率和电压;



conservative: conservative strategy, adjust frequency and voltage step by step.

- ondemand: 根据 CPU 负载动态调频调压,比 interactive 策略反应慢;
 ondemand: dynamically adjust frequency and voltage according to CPU load,
 slower than interactive.
- userspace: 用户自己设置电压和频率,系统不会自动调整;
 userspace: user to set voltage and frequency, system doesn't automatically adjust.
- powersave: 功耗优先,始终将频率设置在最低值;
 powersave: power consumption first, always set the frequency to the lowest value.
- performance: 性能优先,始终将频率设置为最高值;
 performance: performance first, always set the frequency to the max value.

详细的模块功能及配置,请参考 RKDocs/common/driver/目录下《Rockchip CPU-Freq 开发指南 V1.0.1-20170213.pdf》和《Rockchip DEVFreq 开发指南 V1.0-20160701.pdf》文档。

The detailed module function and configuration refer to 《Rockchip CPU-Freq 开发指南 V1.0.1-20170213.pdf》and 《Rockchip DEVFreq 开发指南 V1.0-20160701.pdf》in the directory of RKDocs/common/driver/.

A53/A72/GPU/DDR 分别有对应的调试接口,可以通过 ADB 命令进行操作,对应的接口目录如下: A53/A72/GPU/DDR all have corresponding debugging interface which can be operated with ADB command. The corresponding interface contents are as below:

A53: /sys/devices/system/cpu/cpu0/cpufreq/

A72: /sys/devices/system/cpu/cpu4/cpufreq/

GPU: /sys/class/devfreg/ff9a0000.gpu/

DDR: /sys/class/devfreq/dmc/

这些目录下有如下类似节点:

These contents have below similar nodes:

- available_frequencies: 显示支持的频率 show the supported frequency
- available_governors: 显示支持的变频策略 show the supported frequency scaling



strategy

- cur_freq: 显示当前频率 show current frequency
- Governor: 显示当前的变频策略 show current frequency scaling strategy
- max_freq: 显示当前最高能跑的频率 show current supported max frequency
- min_freq:显示当前最低能跑的频率 show current supported min frequency
 以 GPU 为例进行定频操作,流程如下:

Take GPU as example to do the fixed frequency operation. The process is as below:

- 查看支持哪些频率
 - Check the supported frequencies cat /sys/class/devfreq/ff9a0000.gpu/available_frequencies
- 切换变频策略
 - Switch the frequency scaling strategy
 echo userspace > /sys/class/devfreq/ff9a0000.gpu/governor
- 定频
 - Fix the frequency
 echo 400000000 > /sys/class/devfreq/ff9a0000.gpu/userspace/set_freq
- 设置完后,查看当前频率
 Check current frequency after setting
 cat /sys/class/devfreq/ff9a0000.gpu/cur_freq

5.7 温控配置 Thermal control configuration

RK3399 芯片的 ARM 核和 GPU 核分别带有温控传感器,可以实时监控 cpu 和 gpu 的温度,并通过算法来控制 cpu 和 gpu 的频率从而控制 cpu 和 gpu 的温度。每个产品的硬件设计和模具不同对应的散热情况也不同,可以通过 dts 中的如下配置进行适当的调整温控参数来适配产品:

RK3399 chipset ARM core and GPU core have separate thermal control sensors which can real-time monitor CPU and GPU temperature and then control CPU and GPU temperatures by controlling CPU and GPU frequency through algorithm. Each product's different hardware design and mold correspond to different heat dissipation situation. The following configurations in dts can be used to adjust thermal control parameters to fit the product:



设置温控开启的温度:

```
Set the temperature to enable the thermal control:
&threshold {
   temperature = <85000>; /* millicelsius */
};
设置温控上限温度:
Set the upper limit of thermal control temperature:
&target {
   temperature = <100000>; /* millicelsius */
};
设置软件关机温度:
Set the software shutdown temperature:
&soc_crit {
   temperature = <105000>; /* millicelsius */
};
配置硬件关机温度:
Configure the hardware shutdown temperature:
&tsadc {
   rockchip,hw-tshut-mode = <1>; /* tshut mode 0:CRU 1:GPIO */
   rockchip,hw-tshut-polarity = <1>; /* tshut polarity 0:LOW 1:HIGH */
   rockchip,hw-tshut-temp = <110000>;
   status = "okay";
};
```

温控的具体说明可以参考 RKDocs\common\driver 目录下《Rockchip Thermal 开发指南 V1.0.1-20170428.pdf》。

The detailed thermal control instruction refers to 《Rockchip Thermal 开发指南 V1.0.1-20170428.pdf》 in the directory of RKDocs\common\driver.

5.8 LPDDR4 配置 LPDDR4 configuration

【注意】从 sdk v4.10 版本开始,lpddr4 频率改为了 416M 和 856M (对应的 dts 按照下面的说明修改),查看版本的命令为:



[Note] Starting from sdk v4.10, lpddr4 frequency is changed to be 416M and 856M (modify the corresponding dts as below instruction). The command to check the version is:

```
ls .repo/manifests -l
total 20
-rwxrw-r-- 1 hgc hgc 335 Apr 12 16:48 RK3399_Release_Note.txt
lrwxrwxrwx 1 hgc hgc 45 Jun 14 10:27 RK3399_Android_Pie_release.xml ->
release_version/rk3399_pie_v4.10_20190614.xmll
```

```
rk3399 使用 lpddr4 的 dts 配置请参考文件: arch/arm64/boot/dts/rockchip/rk3399-tv
e1030q.dtsi,将该文件中的下述3个节点拷贝到对应的产品dts中即可
   RK3399 lpddr4 dts configuration refers to the file:
arch/arm64/boot/dts/rockchip/rk3399-tve1030g.dtsi. Just need to copy below three
nodes in the file to the corresponding product dts:
   &dfi {
      status = "okay";
   };
   &dmc {
          status = "okay";
          center-supply = <&vdd_center>;//这里需要客户根据实际硬件电路来配置
need customer to configure according to the actual hardware circuit here
          system-status-freq = <
                /*system status
                                    freq(KHz)*/
                SYS STATUS NORMAL
                                          856000
                SYS_STATUS_REBOOT
                                         416000
                SYS STATUS SUSPEND
                                          416000
                SYS STATUS VIDEO 1080P 416000
                SYS_STATUS_VIDEO_4K
                                          856000
                SYS_STATUS_VIDEO_4K_10B 856000
                SYS_STATUS_PERFORMANCE 856000
                SYS STATUS BOOST
                                         416000
                SYS_STATUS_DUALVIEW
                                         856000
                SYS STATUS ISP
                                      856000
          >;
          vop-bw-dmc-freq = <
          /* min_bw(MB/s) max_bw(MB/s) freq(KHz) */
                        577
                                416000
```



```
578
                      99999
                               856000
       >;
       auto-min-freq = <416000>;
       auto-freq-en = <0>;
};
&dmc_opp_table {
   compatible = "operating-points-v2";
       opp-200000000 {
              opp-hz = /bits/64 < 200000000>;
              opp-microvolt = \langle 825000 \rangle;
              status = "disabled";
       };
       opp-300000000 {
              opp-hz = /bits/64 < 300000000>;
              opp-microvolt = <850000>;
              status = "disabled";
       };
       opp-400000000 {
              opp-hz = /bits/64 < 400000000>;
              opp-microvolt = <900000>;
       };
       opp-416000000 {
              opp-hz = /bits/64 < 416000000>;
              opp-microvolt = <900000>;
       };
       opp-528000000 {
              opp-hz = /bits/64 < 528000000>;
              opp-microvolt = <900000>;
              status = "disabled";
       };
       opp-600000000 {
              opp-hz = /bits/64 < 600000000>;
              opp-microvolt = <900000>;
              status = "disabled";
       };
       opp-800000000 {
              opp-hz = /bits/64 < 800000000>;
              opp-microvolt = <900000>;
       };
       opp-856000000 {
```



这里需要注意的是,1)lpddr4 我们只支持 400M 和 800M 两档频率(从 v4.10 版本开始, 频率变成了 416M 和 856M),其他频率被 disabled 掉了,所以如果客户要使用同一个 dts 来支持 lpddr4 和其他类型的 ddr,则其他类型的 ddr 也将只有 400M 和 800M 的频率(从 v4.10 版本 开始,频率变成了 416M 和 856M),这个请务必注意;2)以上配置默认开启 DDR 变频功能。lpddr4 的变频功能对声卡的数量有所限制,说明如下:

Here we need to pay attention to that: 1) Ipddr4 only supports 400MHz and 800MHz (starting from v4.10, the frequency is changed to be 416M and 856M), other frequencies are disabled. If customers want to use the same dts to support Ipddr4 and other ddr, other ddr will also only support 400MHz and 800MHz (416M and 856M from v4.10). Please pay attention to this. 2) Above configuration enables DDR frequency scaling function by default. Lpddr4 frequency scaling function has some limitation on the audio card number as described below:

如果 lpddr4 需要变频功能,则需要将音频 buffer 移到 sram 中,RK3399 的 sram 空间有限,可用空间 128k,目前预分配给单个音频流的空间为 32k,所以系统支持的上限声卡数最多只能 2个(32k*2*2,每个声卡包含 playback 和 capture),更多的声卡无法创建成功,除非减小单个流的预分配大小,但这也相对的减小了底下支持的 buffer size max,如果用户层使用声卡想设置更大 buffer 时将受限。需注意,USB 声卡由于未使用 dma,所以不在限制范围内,也就是说,可以有 2个声卡(包含 hdmi、spdif、i2s等接口的声卡)加上多个 usb 声卡。因此,接下来分成两种情况描述:



If need to support lpddr4 frequency scaling function, need to transfer audio buffer to sram. RK3399 sram space is limited, available space is 128k, currently pre-allocated space for single audio stream is 32k, so the system can support only 2 audio card at most (32k*2*2, each audio card includes playback and capture). More audio cards cannot be created successfully unless to decrease the single stream pre-allocated size. However, it also relatively decreases the buffer size max supported by bottom layer and it will be limited if user layer wants to set a larger buffer for audio card. Need to notice that, USB audio card is not subject to the limitation because it doesn't use dma. That means, you can use two audio cards (audio cards with hdmi, spdif, i2s etc. interfaces) and multiple USB audio cards. Therefore, the following description is divided into two cases:

5.8.1 需要 lpddr4 的变频 Need lpddr4 frequency scaling

如果需要 lpddr4 变频,则需要将音频 buffer 移到 sram 中,此时系统最多只能支持 2 个声卡,请按照如下方法进行配置:

If need lpddr4 frequency scaling function, need to transfer audio buffer to sram, and now the system only support 2 audio cards at most. Please follow below steps to confirgure:

1. dts 中添加 sram 节点

Add sram node in dts

```
/* first 64k(0xff8c0000~0xff8d0000) for ddr and suspend */
iram: sram@ff8d0000 {
   compatible = "mmio-sram";
   reg = <0x0 0xff8d0000 0x0 0x20000>; /* 128k */
};
```

2. 相对应的产品 dts 中引用 iram 节点。

Invoke iram node in the corresponding product dts.

```
&dmac_bus {
  iram = <&iram>;
  rockchip,force-iram;
```



};

5.8.2 不需要 lpddr4 变频 Do not need lpddr4 frequency scaling

由于 lpddr4 变频有 2 个声卡的限制,因此如果需要 3 个以上声卡,需要关闭 lpddr4 的变频,即在对应产品的 dts 中将 dmc 节点和 dfi 节点 disable,如下所示:

If need 3 or more audio cards, need to disable lpddr4 frequency scaling function due to the 2 audio cards limitation. That is, to disable the dmc node in the corresponding product dts as shown below:

```
&dmc {
    status = "disabled";
    ... ...
};
&dfi {
    status = "disabled";
};
```

另外,需要确保在内核中删除掉5.8.1 节中描述的2个配置:

Besides, must delete the two kernel configurations described in section 5.8.1.

1. 删除 dts 中的如下配置:

Delete the following configuration in dts:

```
/* first 64k(0xff8c0000~0xff8d0000) for ddr and suspend */
iram: sram@ff8d0000 {
   compatible = "mmio-sram";
   reg = <0x0 0xff8d0000 0x0 0x20000>; /* 128k */
};
```

2. 删除 dts 中的如下配置:

Delete the following configuration in dts:

```
&dmac_bus {
  iram = <&iram>;
  rockchip,force-iram;
};
```



5.9 DSI to LVDS

东芝 TC358775 DSI 转 LVDS 方案的补丁路径:

The patch of Toshiba TC358775 DSI to LVDS solution is placed in:

../RKDocs/rk3399/patches/display/toshiba_tc358775_18.12.06.rar

6 Android 常见配置 Android common configuration

6.1 Android9.0 系统新特性说明 Android9.0 new feature instruction

该部分内容请参阅 sdk 中 RKDocs/rk3399 目录下《Android_9.0 系统新特性说明_V1.1_20181205.pdf》。

Please refer to 《Android_9.0 系统新特性说明_V1.1_20181205.pdf》 in the directory of RKDocs/rk3399 in sdk.

6.2 Android 产品配置 Android product configuration

6.2.1 lunch 选项说明 lunch option description

rk3399-userdebug: //rk3399 平台平板产品 userdebug(64 位) rk3399 platform tablet product userdebug (64bit)

rk3399-user: //rk3399平台平板产品 user(64位) rk3399 platform tablet product user (64bit)

6.2.2 添加一个新的产品 Create a new product

RK3399 平台支持平板、Laptop、Box 等产品形态,当需要添加一个新的产品时,可以基于己有的 RK3399 来建立,如下以建立一个新的平板产品为例进行说明,具体步骤为:

RK3399 platform supports tablet, Laptop, Box etc. products. You can create a new product based on existing RK3399. Below take a new tablet product as example to describe the detailed steps:

● 在 device/rockchip/rk3399/目录下,基于 rk3399_mid.mk 创建 rk3399_xxx.mk。

Create rk3399_xxx.mk based on rk3399_mid.mk in the directory of device/rockchip/rk3399/.

cd device/rockchip/rk3399 mkdir rk3399_xxx



cp rk3399_mid.mk ./rk3399_xxx.mk cp rk3399 mid/* rk3399 xxx/

● 在 device/rockchip/rk3399/AndroidProducts.mk 中添加:

Add in device/rockchip/rk3399/AndroidProducts.mk:

PRODUCT_MAKEFILES := \
\$(LOCAL_DIR)/rk3399.mk \
\$(LOCAL_DIR)/rk3399_xxx.mk

● 在 vendorsetup.sh 中添加产品对应的 lunch 选项:

Add the corresponding lunch option of the product in vendorsetup.sh:

add_lunch_combo rk3399-userdebug

add_lunch_combo rk3399-user

add_lunch_combo rk3399_mid-userdebug

add_lunch_combo rk3399_mid-user

add_lunch_combo rk3399_xxx-userdebug

add_lunch_combo rk3399_xxx-user

● 修改 rk3399_ xxx.mk 中新产品所需要修改的配置。

Modify the configurations for the new product in rk3399 xxx.mk.

● 修改编译脚本或编译命令,重新 lunch 产品名称进行新产品编译。

Modify the compiling script or compiling command, re-lunch the product name to compile the new product.

6.3 常用功能配置说明 Common function configuration instruction

6.3.1 常用配置宏说明 Common configuration macro instruction

宏配置	功能说明		
Macro configuration	Function instruction		
BUILD_WITH_GOOGLE_MARKET	若为 true 则集成 GMS 包,false 不集成		
	If true, integrate GMS package,		
	false not to integrate		
BUILD_WITH_GOOGLE_MARKET_ALL	若为 true 集成 full 的 GMS 包,false 集		
	成 mini 的 GMS 包		



	If true, integrate full GMS package,		
	false to integrate mini GMS package		
BUILD_WITH_GOOGLE_FRP	使能恢复出厂设置保护 FRP 功能		
	Enable FRP factory reset protection		
	function		
BUILD_WITH_FORCEENCRYPT	使能默认全盘加密		
	Enable default full disk encryption		
PRODUCT_SYSTEM_VERITY	使能 Verified boot		
	Enable Verified boot		
BUILD_WITH_GMS_CER	GMS 认证配置选项		
	GMS certificate configuration option		
BUILD_WITH_WIDEVINE	集成 Widevine level3 插件库		
	Integrate Widevine level3 plug-in		
	library		
BOARD_NFC_SUPPORT	使能 NFC 功能		
	Enable NFC function		
BOARD_SENSOR_ST	选用 ST 的 sensor 框架		
	Select ST sensor framework		
BOARD_SENSOR_MPU	选用 MPU 的 sensor 框架		
	Select MPU sensor framework		
BOARD_SENSOR_MPU_VR	选用 MPU_VR 的 sensor 框架		
	Select MPU_VR sensor framework		
BOARD_GRAVITY_SENSOR_SUPPORT	使能 G-Sensor		
	Enable G-Sensor		
BOARD_COMPASS_SENSOR_SUPPORT	使能 Compass		
	Enable Compass		
BOARD_GYROSCOPE_SENSOR_SUPPORT	使能陀螺仪 Gyroscope		
	Enable Gyroscope		
BOARD_PROXIMITY_SENSOR_SUPPORT	使能距离感应器		
ı.			



	Enable P-sensor	
BOARD_LIGHT_SENSOR_SUPPORT	使能光感应器	
	Enable the light sensor	
BOARD_PRESSURE_SENSOR_SUPPORT	使能压力感应器	
	Enable the pressure sensor	
BOARD_TEMPERATURE_SENSOR_SUPPORT	使能温度传感器	
	Enable the temperature sensor	
BOARD_ENABLE_3G_DONGLE	使能 3G Dongle 功能	
	Enable 3G Dongle function	
TARGET_ROCKCHIP_PCBATEST	使能 PCBA 测试	
	Enable PCBA test	
BOOT_SHUTDOWN_ANIMATION_RINGING	使能开关机动画+铃声	
	Enable power on/off animation and	
	tones	
BOARD_SYSTEMIMAGE_PARTITION_SIZE	System 分区最大容量	
	System partition maximum capacity	

6.3.2 预装 APK Pre-install APK

Android 上的应用预安装功能,主要是指配置产品时,根据厂商要求,将事先准备好的第三方应用预制进 Android 系统。预安装分为不可卸载安装、可永久卸载安装以及卸载后恢复出厂设置后自动恢复安装,详细配置和使用请参阅工程目录 RKDocs/android/下相关说明文档:

《Android_预安装应用功能说明文档_V1.0_20171109.pdf》。

Android apk pre-install function means to install the third application prepared in advance into the Android system when configuring the product according to customer requirements. Pre-install can be divided into non-uninstall installation, permanent uninstall installation and automatic installation after factory reset. Please refer to below document in the project directory of RKDocs/android/ for the detailed configuration and usage: 《Android_预安装应用功能说明文档_V1.0_20171109.pdf》.

6.3.3 开/关机动画及铃声 Power on/off animation and tones

定制 Android9.0 的开机铃声,关机铃声,开机动画,关机动画的详细方法请参阅工程目录 R



KDocs/android/下的说明文档:《Android_定制开关机动画(铃音)说明_V1.0_20181112.p df》。

Android9.0 power on tones, power off tones, power on animation, and power off animation customizations refer to the document 《Android_定制开关机动画(铃音) 说明_V1.0_20181112.pdf》 in the project directory of RKDocs/android/.

6.4 Parameter 说明 Parameter instruction

rk3399 Android 9.0 平台有平板、Box、Laptop 等产品形态,不同的产品形态可能需要不同的 parameter 参数,关于 parameter 中各个参数、分区情况细节,请参考\RKDocs\common\RKTools manuals\ Rockchip Parameter File Format Ver1.3.pdf。

RK3399 Android9.0 platform supports tablet, Box, Laptop etc. product types and different product types may need different parameter. For the parameter and partition details, please refer to \RKDocs\common\RKTools manuals\ Rockchip Parameter File Format Ver1.3.pdf.

6.5 新增分区配置 New partition configuration

请参考\RKDocs\android\《Android 增加一个分区配置指南 V1.00.pdf》。

Please refer to \RKDocs\android\《Android 增加一个分区配置指南 V1.00.pdf》.

6.6 OTA 升级 OTA upgrade

OTA (over the air)升级是 Android 系统提供的标准软件升级方式。它功能强大,提供了完全升级(完整包)、增量升级模式(差异包),可以通过本地升级,也可以通过网络升级。详细的 OTA 升级及 Recovery 模块功能及配置,请参考 RKDocs\android 目录下《Rockchip Recovery 用户操作指南 V1.05》。

OTA (over the air) upgrade is the standard software upgrade method provided by Android system. It provides complete upgrading (full package) and incremental upgrading mode (difference package). You can upgrade locally or over the network. For the detailed OTA upgrade and Recovery mode function and configuration, please refer to 《Rockchip Recovery 用户操作指南 V1.05》 in the directory of RKDocs\android.

7系统调试 System debug

本节重点介绍 SDK 开发过程中的一些调试工具和调试方法,并会不断补充完善,帮助开发者快速上手基础系统调试,并做出正确的分析。



This chapter mainly introduces the debugging tools and methods used in SDK development and will update and improve continually to help developers familiar with the basic system debugging quickly and analyze the issues correctly.

7.1 ADB 工具 ADB tool

7.1.1 概述 Overview

ADB (Android Debug Bridge) 是 Android SDK 里的一个工具,用这个工具可以操作管理 Android 模拟器或真实的 Android 设备。主要功能有:

ADB (Android Debug Bridge) is a tool in Android SDK which can be used to operate and manage Android simulator or the real Android device. The functions mainly include:

- 运行设备的 shell (命令行)
 - Run the device shell (command line)
- 管理模拟器或设备的端口映射
 - Manage the port mapping of the simulator or the device
- 计算机和设备之间上传/下载文件
 - Upload/download files between the computer and the device
- 将本地 apk 软件安装至模拟器或 Android 设备
 - Install the local apk to simulator or Android device

ADB 是一个"客户端一服务器端"程序,其中客户端主要是指 PC,服务器端是 Android 设备的实体机器或者虚拟机。根据 PC 连接设备的方式不同,ADB 可以分为两类:

ADB is a "client – server" program. Usually the client is PC and the server is the actual Android device or simulator. The ADB can be divided into two categories according to the way PC connects to the device:

- 网络 ADB: 主机通过有线/无线网络(同一局域网)连接到 STB 设备 Network ADB: PC connects to STB device through cable/wireless network
- USB ADB: 主机通过 USB 线连接到 STB 设备

USB ADB: PC connects to STB device through USB cable

7.1.2 USB ADB 使用说明 USB ADB usage

USB ADB 使用有以下限制:

USB ADB usage has below limitations:



● 只支持 USB OTG 口

Only support USB OTG port

● 不支持多个客户端同时使用(如 cmd 窗口, eclipse 等)

Not support multiple clients at the same time (such as cmd window, eclipse etc.)

- 只支持主机连接一个设备,不支持连接多个设备
- Support host connects to only one device but multiple devices

连接步骤如下:

The connection steps are as below:

1、设备已经运行 Android 系统,设置->开发者选项->已连接到计算机打开,usb 调试开关打开。

The device already running Android system, setting -> developer option -> connect to the computer, enable usb debugging switch.

2、PC 主机只通过 USB 线连接到机器 USB OTG 口,然后电脑通过如下命令与设备相连。

PC connects to the device USB OTG port only through USB cable, and then the computer connects with the device through below command:

adb shell

3、测试是否连接成功,运行"adb devices"命令,如果显示机器的序列号,表示连接成功。

Execute the command "adb devices" to see if the connection is successful or not. If the device serial number shows up, the connection is successful.

7.1.3 网络 ADB 使用要求 Network ADB use requirement

ADB 早期版本只能通过 USB 来对设备调试,从 adb v1.0.25 开始,增加了通过 tcp/ip 调试 Android 设备的功能。

ADB early versions only support device debugging through USB, and the function of debugging Android devices through tcp/ip is added from adb v1.0.25.

如果你需要使用网络 ADB 来调试设备,必须要满足如下条件:

If you need to use network ADB to debug the device, must meet below conditions:

1、设备上面首先要有网口,或者通过 Wi-Fi 连接网络。

The device must have network port, or connect the network through Wi-Fi.

2、设备和研发机(PC 机)已经接入局域网,并且设备设有局域网的 IP 地址。



The device and PC are already in the local network and the device has IP address.

3、要确保研发机和设备能够相互 ping 得通。

Need to confirm the device and PC can ping each other.

4、研发机已经安装了ADB。

PC already installs ADB.

5、确保 Android 设备中 adbd 进程(ADB 的后台进程)已经运行。adbd 进程将会监听端口 5555 来进行 ADB 连接调试。

Confirm Android device adbd process (ADB backaground process) is already run. adbd process will monitor port 5555 to do ADB connection debugging.

7.1.4 SDK 网络 ADB 端口配置 SDK network ADB port configuration

SDK 默认未对网络 ADB 端口进行配置,需要手动修改打开配置。

SDK doesn't configure network ADB port by default. Need to manually modify to open the configuration.

修改 device/rockchip/rkxxxx/device.mk 文件, 在 PRODUCT_PROPERTY_OVERRIDES 后面追加如下配置:

Modify device/rockchip/rkxxxx/device.mk file, and add below configuration behind PRODUCT PROPERTY OVERRIDES:

service.adb.tcp.port=5555

7.1.5 网络 ADB 使用 Network ADB usage

本节假设设备的 IP 为 192.168.1.5,下文将会用这个 IP 建立 ADB 连接,并调试设备。

This chapter assumes the device IP is 192.168.1.5. This IP will be used for ADB connection and device debugging in the following context.

1、首先 Android 设备需要先启动,如果可以话,可以确保一下 adbd 启动(ps 命令查看)。

Firstly the Android device should boot up, if possible, confirm adbd is started (use ps command to check).

2、在 PC 机的 cmd 中,输入:

In PC cmd, input:

adb connect 192.168.1.5:5555

如果连接成功会进行相关的提示,如果失败的话,可以先 kill-server 命令,然后重试连接。

If successful, it will prompt relative hints, if fail, you can execute kill-server



command and then retry connection.

adb kill-server

3、如果连接已经建立,在研发机中,可以输入 ADB 相关的命令进行调试了。比如 adb shell,将会通过 TCP/IP 连接设备上面。和 USB 调试是一样的。

After connected, you can input ADB relative commands to debug in PC, such as adb shell, it will connect the device through TCP/IP which is the same as USB debugging.

4、调试完成之后,在研发机上面输入如下的命令断开连接:

After debugging, input below command to disconnect the connection in PC:

adb disconnect 192.168.1.5:5555

7.1.6 手动修改网络 ADB 端口号 Manually modify the network ADB port number

若 SDK 未加入 ADB 端口号配置,或是想修改 ADB 端口号,可通过如下方式修改:

If SDK doesn't add ADB port number configuration, or want to change ADB port number, you can change through below method:

1、首先还是正常地通过 USB 连接目标机,在 windows cmd 下执行 adb shell 进入。

Firstly also connect the device normally through USB, execute adb shell in windows cmd to enter.

2、设置 ADB 监听端口:

Set ADB monitor port:

#setprop service.adb.tcp.port 5555

3、通过 ps 命令查找 adbd 的 pid

Look up adbd pid using ps command.

4、重启 adbd

Reset adbd.

#kill -9<pid>,这个pid 就是上一步找到那个pid

杀死 adbd 之后,Android 的 init 进程会自动重启 adbd。adbd 重启后,发现设置了 service. adb.tcp.port,就会自动改为监听网络请求。

After killing adbd, adbd will automatically restart after Android init process. After adbd restart, if service.adb.tcp.port is set, it will automatically change to monitor network request.



7.1.7 ADB 常用命令详解 ADB commonly used command elaberation

(1) 查看设备情况

Check the device situation

查看连接到计算机的 Android 设备或者模拟器:

Check the Android device or simulator connected to computer:

adb devices

返回的结果为连接至开发机的 Android 设备的序列号或是 IP 和端口号(Port)、状态。

The return result is the serial number or IP and port number, status of the Android device connected to PC.

(2) 安装 APK

Install APK

将指定的 APK 文件安装到设备上:

Install the specific APK file to the device:

adb install <apk 文件路径>

示例如下:

For example:

adb install "F:\WishTV\WishTV.apk"

重新安装应用:

Re-install application:

adb install - r <apk 文件路径>

示例如下:

For example:

adb install - r "F:\WishTV\WishTV.apk"

(3) 卸载 APK

Uninstall APK

完全卸载:

Complete uninstall:

adb uninstall <package>

示例如下:

For example:



adb uninstall com.wishtv

(4) 使用 rm 移除 APK 文件:

Use rm to remove APK file:

adb shell rm <filepath>

示例如下:

For example:

adb shell

rm "system/app/WishTV.apk"

示例说明:移除"system/app"目录下的"WishTV.apk"文件。

Note: remove WishTV.apk file in the directory of system/app.

(5) 进入设备和模拟器的 shell

Enter shell of the device and simulator

进入设备或模拟器的 shell 环境:

Enthe the shell environment of the device or simulator:

adb shell

(6) 从电脑上传文件到设备

Upload file to the device from computer

用 push 命令可以把本机电脑上的任意文件或者文件夹上传到设备。本地路径一般指本机电脑;远程路径一般指 ADB 连接的单板设备。

Use push command can upload any file or folder from computer to the device. Generally local path means the computer and remote path means the single board device connected with ADB.

adb push <本地路径 local path><远程路径 remote path>

示例如下:

For example:

adb push "F:\WishTV\WishTV.apk" "system/app"

示例说明:将本地"WishTV.apk"文件上传到 Android 系统的"system/app"目录下。

Note: upload local WishTV.apk file to the system/app directory of the Android system.

(7) 从设备下载文件到电脑



Download file from the device to computer

pull 命令可以把设备上的文件或者文件夹下载到本机电脑中。

Use pull command can download file or folder from the device to local computer.

adb pull <远程路径><本地路径>

示例如下:

For example:

adb pull system/app/Contacts.apk F:\

示例说明:将 Android 系统 "system/app" 目录下的文件或文件夹下载到本地 "F:\" 目录下。

Note: download the file or folder from the system/app directory of Android system to local F:\ directory.

(8) 查看 bug 报告

Check bug report

需要查看系统生成的所有错误消息报告,可以运行 adb bugreport 指令来实现,该指令会将 Android 系统的 dumpsys、dumpstate 与 logcat 信息都显示出来。

Run adb bugreport command can check all the error message report generated by system. The command will show all dumpsys, dumpstate and logcat information of the Android system.

(9) 查看设备的系统信息

Check the device system information

在 adb shell 下查看设备系统信息的具体命令。

The specific commands to check the device system information in adb shell.

adb shell getprop

7.2 Logcat 工具 Logcat tool

Android 日志系统提供了记录和查看系统调试信息的功能。日志都是从各种软件和一些系统的缓冲区中记录下来的,缓冲区可以通过 Logcat 来查看和使用。Logcat 是调试程序用的最多的功能。该功能主要是通过打印日志来显示程序的运行情况。由于要打印的日志量非常大,需要对其进行过滤等操作。

Android logcat system provides the function to record and check the system debugging information. The logcats are all recorded from various softwares and some



system buffer. The buffer can be checked and used through Logcat. Logcat is the most commonly used function for debugging program. The function shows the program running status mainly by printing logcat. Because the amount of logcat is very large, need to do filtering and other operations.

7.2.1 Logcat 命令使用 Logcat command usage

用 logcat 命令来查看系统日志缓冲区的内容:

Use logcat command to check the contents of the system logcat buffer:

基本格式:

The basic format:

[adb] logcat [<option>] [<filter-spec>]

示例如下:

For example:

adb shell

logcat

7.2.2 常用的日志过滤方式 The commonly used logcat filter method

控制日志输出的几种方式:

Several ways to control the logcat output:

● 控制日志输出优先级。

Control the logcat output priority.

示例如下:

For example:

adb shell

logcat *:W

示例说明:显示优先级为 warning 或更高的日志信息。

Note: show the logcat information with priority of warning or higher.

● 控制日志标签和输出优先级。

Control the logcat label and output priority.

示例如下:

For example:

adb shell



logcat ActivityManager:I MyApp:D *:S

示例说明:支持所有的日志信息,除了那些标签为"ActivityManager"和优先级为"Info"以上的、标签为"MyApp"和优先级为"Debug"以上的。

Note: support all the logical information except those with label of ActivityManager and priority of Info above, label of MyApp and priority of Debug above.

● 只输出特定标签的日志

Only output the logcat with the specific label

示例如下:

For example:

adb shell

logcat WishTV:* *:S

或者

Or

adb shell

logcat -s WishTV

示例说明: 只输出标签为 WishTV 的日志。

Note: only output the logcat with label of WishTV.

● 只输出指定优先级和标签的日志

Only output the logcat with the specific priority and label

示例如下:

For example:

adb shell

logcat WishTV:I *:S

示例说明:只输出优先级为 I,标签为 WishTV 的日志。

Note: only output the logcat with priority of I and label of WishTV.

7.2.3 查看上次 log View last log

可以加-L 参数来打印出上次系统复位前的 logcat 信息。若出现拷机异常或者异常掉电的情况,可通过该命令打印出上一次 Android 运行状态的日志。命令如下:

Add –L parameter can print out the logcat information before last system reset. If the stress test and power down abnormal occur, the command can be used to print out



the logcat of last Android running status. The command is as below:

adb shell

logcat -L

7.3 Procrank 工具 Procrank tool

Procrank 是 Android 自带一款调试工具,运行在设备侧的 shell 环境下,用来输出进程的内存快照,便于有效的观察进程的内存占用情况。

Procrank is a debugging tool with Android, running in the shell environment of the device, used to output the memory snapshot of the process in order to effectively observe the memory usage status of the process.

包括如下内存信息:

Include below memory information:

- VSS: Virtual Set Size 虚拟耗用内存大小(包含共享库占用的内存) The memory size used by virtual (including the memory used by the shared lib)
- RSS: Resident Set Size 实际使用物理内存大小(包含共享库占用的内存) The actually used physical memory size (including the memory used by the shared lib)
- PSS: Proportional Set Size 实际使用的物理内存大小(比例分配共享库占用的内存)
 The actually used physical memory size (allocate the memory used by the shared lib in proportion)
- USS: Unique Set Size 进程独自占用的物理内存大小(不包含共享库占用的内存) The physical memory used exclusively by the process (not including the memory used by the shared lib)



注意: Note:

- USS 大小代表只属于本进程正在使用的内存大小,进程被杀死后会被完整回收; USS size represents the memory size only used by the process, and it will be recovered completely after the process is killed.
- VSS/RSS 包含了共享库使用的内存,对查看单一进程内存状态没有参考价值;
 VSS/RSS includes the memory used by the shared lib, so it is not helpful to check the memory status of the single process.
- PSS 是按照比例将共享内存分割后,某单一进程对共享内存区的占用情况。
 PSS is the shared memory status used by the specific single process after the shared memory is allocated in proportion.

7.3.1 使用 procrank Use procrank

执行 procrank 前需要先让终端获取到 root 权限

Make sure the terminal has the root authority before executing procrank

su

命令格式:

The command format:

procrank [-W] [-v | -r | -p | -u | -h]

常用指令说明:

The commonly used command instructions:

- -v: 按照 VSS 排序 order by VSS
- -r: 按照 RSS 排序 order by RSS
- -p: 按照 PSS 排序 order by PSS
- -u: 按照 USS 排序 order by USS
- R: 转换为递增[递减]方式排序 convert to order by increasing[decreasing] method
- -w: 只显示 working set 的统计计数 only display the statistical count of working set
- -W: 重置 working set 的统计计数 reset the statistical count of working set
- -h: 帮助 help

示例:

For example:



-输出内存快照: Output the memory snapshot:

procrank

-按照 VSS 降序排列输出内存快照: Output the memory snapshot in VSS decreasing order:

procrank - v

默认 procrank 输出是通过 PSS 排序。Procrank is output in PSS order by default.

7.3.2 检索指定内容信息 Search the specific content information

查看指定进程的内存占用状态,命令格式如下:

Use below command format to view the memory status of the specific process:

procrank | grep [cmdline | PID]

其中 cmdline 表示需要查找的应用程序名, PID 表示需要查找的应用进程。

cmdline means the target application name, PID means the target application process.

输出 systemUI 进程的内存占用状态:

Output the memory status used by systemUI process:

procrank | grep "com.android.systemui"

或者: Or:

procrank | grep 3396

7.3.3 跟踪进程内存状态 Trace the process memory status

通过跟踪内存的占用状态,进而分析进程中是否存在内存泄露场景。使用编写脚本的方式,连续输出进程的内存快照,通过对比 USS 段,可以了解到此进程是否内存泄露。

Analyze if there is memory leakage in the process by tracing the memory usage status. Use the script to continuously output the process memory snapshot, and compare with USS segment to see if there is memory leakage in this process.

示例:输出进程名为 com.android.systemui 的应用内存占用状态,查看是否有泄露:

For example: output the application memory usage of the process named com.android.systemui to see if there is leakage:

1、编写脚本 test.sh

Write the script test.sh

#!/bin/bash



```
while true;do
adb shell procrank | grep "com.android.systemui"
sleep 1
done
```

2、通过 ADB 工具连接到设备后,运行此脚本: ./test.sh。如图所示。

After connect to the device by ADB tool, run the script ./test.sh as shown in below picture:

2226	49024K	48692K	30259K	27596K	com. android. systemui
2226	49036K	48704K	30271K	27608K	com. android. systemui
2226	49040K	48708K	30275K	27612K	com. android. systemui
2226	49040K	48708K	30275K	27612K	com.android.systemui
2226	49040K	48708K	30275K	27612K	com. android. systemui
2226	49040K	48708K	302 75 K	27612K	com.android.systemui

图 7-1 跟踪进程内存状态

Picture 7-1 Trace the process memory status

7.4 Dumpsys 工具 Dumpsys tool

Dumpsys 工具是 Android 系统中自带的一款调试工具,运行在设备侧的 shell 环境下,提供系统中正在运行的服务状态信息功能。正在运行的服务是指 Android binder 机制中的服务端进程。

Dumpsys tool is a debugging tool in Android system, running in the shell environment of the device, and provides the status information of the running service in the system. The running service means the service process in the Android binder mechanism.

dumpsys 输出打印的条件:

The conditions for dumpsys to output the print:

1、只能打印已经加载到 ServiceManager 中的服务;

Only print the services already loaded to ServiceManager.

2、如果服务端代码中的 dump 函数没有被实现,则没有信息输出。

If the dump function in the service code is not implemented, there will be no information output.

7.4.1 使用 Dumpsys Use Dumpsys

● 查看 Dumpsys 帮助

View Dumpsys help



作用:输出 dumpsys 帮助信息。

Function: output dympsys help information.

dumpsys -help

● 查看 Dumpsys 包含服务列表

View the service list of Dumpsys

作用:输出 dumpsys 所有可打印服务信息,开发者可以关注需要调试服务的名称。

Function: output all the printable service information of dumpsys, developer can pay attention to the service names required for debugging.

dumpsys -I

● 输出指定服务的信息

Output the specific service information

作用:输出指定的服务的 dump 信息。

Function: output the specific service dump information.

格式: dumpsys [servicename]

Format: dumpsys [servicename]

示例:输出服务 SurfaceFlinger 的信息,可执行命令:

For example: execute below command can output the service information of SurfaceFlinger

dumpsys SurfaceFlinger

● 输出指定服务和应有进程的信息

Output the specific service and application process information

作用:输出指定服务指定应用进程信息。

Function: output the specific service and application process information

格式: dumpsys [servicename] [应用名]

Format: dumpsys [servicename] [application name]

示例:输出服务名为 meminfo,进程名为 com.android.systemui 的内存信息,执行命令:

For example: execute below command to output the memory information for the service named meminfo and process named com.android.systemui.

dumpsys meminfo com.android.systemui

注意: 服务名称是大小写敏感的,并且必须输入完整服务名称。



Note: the service name is case sensitive and must input the full service name.

7.5 串口调试 Serial port debugging

7.5.1 串口配置 Serial port configuration

调试过程中最方便的就是串口的输入输出,这里需要注意的是 RK3399 波特率设置为1500000。RTS/CTS 不要勾选,否则串口无法输入。

The serial input and output is the most convenient during debugging. Need to note that RK3399 baud rate is set as 1500000. No need to choose RTS/CTS, otherwise the serial port cannot be input.

7.5.2 FIQ 模式 FIQ mode

快速中断请求(Fast Interrupt Request, FIQ)在 ARM 中,FIQ 模式是特权模式中的一种,同时也属于异常模式一类。

FIQ (Fast interrupt request) in ARM is a kind of privilege modes and also one of the abnormal modes.

RK 平台上,在串口输入"fiq",可以进入该模式。此时会有使用帮助跳出,可根据情况进行一些调试。经常在死机,或系统卡死的时候起作用。

In RK platforms, input fig through serial port can enter this mode. At this mo ment the usage help will pop out and you can do some debugging according to t he situation. Usually it is helpful when crash or system die happens.

7.6 音频 codec 问题调试工具及文档 Audio codec issue debugging tool and document

请参考RKDocs\common\driver\ Rockchip Audio 开发指南 V1.1-20170215-linux4.4. pdf。

Please refer to RKDocs\common\driver\ Rockchip Audio 开发指南 V1.1-2017021 5-linux4.4.pdf.

7.7 Last log 开启 Last log enable

在 dts 文件里面添加下面两个节点:

Add below two nodes in dts file:

```
ramoops_mem: ramoops_mem {
    reg = <0x0 0x110000 0x0 0xf0000>;
    reg-names = "ramoops_mem";
};
```



```
ramoops {
    compatible = "ramoops";
    record-size = <0x0 0x20000>;
    console-size = <0x0 0x80000>;
    ftrace-size = <0x0 0x00000>;
    pmsg-size = <0x0 0x50000>;
    memory-region = <&ramoops_mem>;
};
```

• 130|root@rk3399:/sys/fs/pstore # Is

```
上次内核 panic 后保存的 log。

dmesg-ramoops-0 Log saved after last kernel panic

pmsg-ramoops-0 上次用户空间的 log,android 的 log。

pmsg-ramoops-0 Log of last user space, android log

ftrace-ramoops-0 打印某个时间段内的 function trace。

ftrace-ramoops-0 Print function trace during some period.

console-ramoops-0 last_log 上次启动的 kernel log,但只保存了优先级比默认 log
```

console-ramoops-0 The kernel log for the last boot of last_log, but only save the log with higher priority than default log level.

● 使用方法: Usage method:

level 高的 log。

```
cat dmesg-ramoops-0 cat console-ramoops-0
```

logcat -L (pmsg-ramoops-0) 通过 logcat 取出来并解析 pull out by logcat and parse

cat ftrace-ramoops-0

8 常用工具说明 Commonly used tool instruction

本节简单介绍 SDK 附带的一些开发及量产工具的使用说明,方便开发者了解熟悉 RK 平台工具的使用。详细的工具使用说明请见 RKTools 目录下各工具附带文档,及 RKDocs\ common\ RK Tools manuals 目录下工具文档。

This chapter simply describes some developing and MP tools usage along with SDK to help the developers familiar with RK platform tool usage. The detailed tool usage



refers to the tool related documents in the directory of RKTools and RKDocs\ common\ RKTools manuals.

8.1 StressTest

设备上使用 Stresstest 工具,对待测设备的各项功能进行压力测试,确保各项整个系统运行的稳定性。SDK 通过打开计算器应用,输入"83991906="暗码,可启动 StressTest 应用,进行各功能压力测试。

Use the Stresstest tool to do the stress test for the vasious functions on the target devices to make sure the whole system running stably. SDK can start StressTest application and conduct stress test of various functions by opening the calculator and entering "83991906=" code.

Stresstest 测试工具测试的内容主要包括:

The test items of Stresstest tool mainly include:

模块相关

Module related

- Camera 压力测试:包括 Camera 打开关闭,Camera 拍照以及 Camera 切换。
 Camera stress test: including Camera on/off, Camera taking photo and Camera switch.
- Bluetooth 压力测试:包括 Bluetooth 打开关闭。

Bluetooth stress test: including Bluetooth on/off.

Wi-Fi 压力测试:包括 Wi-Fi 打开关闭, (ping 测试以及 iperf 测试待加入)。
 WiFi stress test: including WiFi on/off, (plan to add ping test and iperf test).

非模块相关

Non module related

- 飞行模式开关测试 fly mode on/off test
- 休眠唤醒拷机测试 sleep and resume stress test
- 视频拷机测试 video playing stress test



- 重启拷机测试 restart stress test
- 恢复出厂设置拷机测试 recovery stress test
- ARM 变频测试 ARM frequency scaling test
- GPU 变频测试 GPU frequency scaling test
- DDR 变频测试 DDR frequency scaling test

8.2 PCBA 测试工具 PCBA test tool

PCBA 测试工具用于帮助在量产的过程中快速地甄别产品功能的好坏,提高生产效率。目前包括屏幕(LCD)、无线(WiFi)、蓝牙(Bluetooth)、DDR/eMMC 存储、SD卡(SDCard)、USB HOST、按键(Key),喇叭耳机(Codec)测试项目。

PCBA test tool is used to help quickly identify good and bad product features during production to improve the production efficiency. Current test items include panel (LCD), wireless (Wi-Fi), Bluetooth, DDR/eMMC memory, SD card, USB HOST, key, speaker earphone (Codec).

这些测试项目包括自动测试项和手动测试项。无线网络、DDR/eMMC、以太网为自动测试项,按键、SD 卡、USB Host、Codec、为手动测试项目。

These test items include automatic test item and manual test item. Wireless network, DDR/eMMC, Ethernet are automatic test items, while key, SD card, USB Host, Codec are manual test items.

具体 PCBA 功能配置及使用说明,请参考:

For detailed PCBA function configuration and usage, pleaes refer to:

\RKDocs\common\RKTools manuals\Rockchip PCBA 模块开发指南--20170210.pdf

8.3 DDR测试工具 DDR test tool

设备上使用 DDR 测试工具,对待测设备的 DDR 进行稳定性测试,确保 DDR 功能正常及稳定。 本平台 DDR 测试工具还未发布,后续会随 SDK 更新。

Use DDR test tool to do the stability test on the target devices to make sure DDR function normal and stable. Currently DDR test tool of this platform is not released yet,



and it will be updated along with SDK later.

8.4 Android 开发工具 Android development tool

8.4.1 下载镜像 Download the mirror image

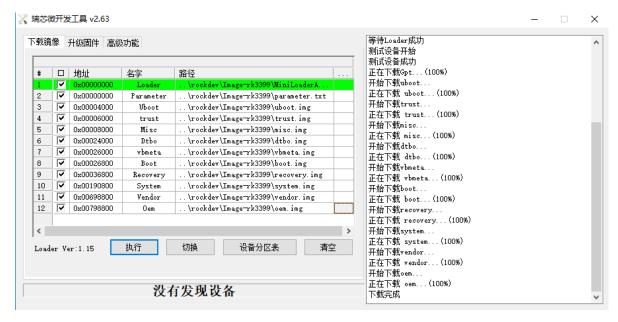


图 8-1 Android 开发工具下载镜像

Picture 8-1 Use Android development tool to download the mirror image

1) 连接开发板进入下载模式。

Connect the development board to enter the download mode.

下载模式: 先按住开发板 reset 按键,再长按 recovery 按键约 3-4s 时间进入。

Download mode: Firstly press reset key of the development board, and then long press recovery key around 3-4s to enter.

2) 打开工具,点击"下载镜像"菜单。单击每一行末尾红色箭头所指处,会弹出文件选择框。 选择对应分区的 img 文件路径。

Open the tool, and click "download mirror image" menu. Single click every line end as marked with red arrow, it will pop out file selection box and then choose the img file path of the corresponding partition.

3) 依次设置所有 img 文件的路径。

Set all the img file paths successively.

4) 配置完成后,点击"执行"。右侧信息框将显示相关信息。



After configuration, click "execute". The right information box will display the relative information.

5) 按钮说明

Button description

"低格"按钮:用于擦除设备

"低格" button: Used to erase the device

"清空"按钮:清空信息框

"清空" button: Used to clean up the information box

8.4.2 升级固件 Upgrade image



图 8-2 Android 开发工具升级固件

Picture 8-2 Use Android development tool to upgrade image

1) 准备目标固件。(可参考 update.img 打包)

Prepare the target image (refer to update.img package).

2) 确认设备已经进入下载模式。

Confirm the device is already in the download mode.

下载模式进入方法: 先按住开发板 reset 按键,再长按 recovery 按键约 3-4s 时间进入。

The way to enter the download mode: Firstly press reset key of the



development board, and then long press recovery key around 3-4s to enter.

3) 点击"固件"按钮,选择目标固件 update.img 文件。

Click "image" button, and choose the target image file update.img.

4) 点击"升级"按钮进行下载。右侧信息框将显示相关信息。

Click "upgrage" button to download. The right information box will display the relative information.

8.4.3 高级功能 Senior functions



图 8-3 Android 开发工具高级功能

Picture 8-3 Android development tool senior functions

高级功能说明:

Senior functions description:

1) Boot 只能选择打包好的 update.img 文件或是 loader 文件。

Boot can only select the packed update.img file or loader file.

2) 固件必须使用打包后的 update.img。

Image must use the packed update.img.

3) 解包功能可将 update.img 拆解为各部分镜像文件。

The unpack function can unpack update.img into partial mirror files.



8.5 update.img 打包 update.img pack

本平台支持将各零散镜像文件,打包成一个完整的 update.img 形式,方便量产烧写及升级。 具体打包步骤如下:

This platform supports to pack the scattered mirror files into one complete update.img to benefit production flashing and upgrading. The detailed packing steps are as below:

- 打开 AndroidTool 工具目录底下的 rockdev 目录。编辑 package-file。
 Open the rockdev directory under AndroidTool directory. Compile package-file.
- 2) 按照 package-file 进行配置,package-file 里面有一些 img 镜像放在 Image 目录底下的,如果没有该目录存在,则自己手工新建该 Image 目录,并将需要放到 Image 目录的镜像放进去即可。且注意配置时,镜像名字的准确。其中注意 bootloader 选项,应该根据自己生成的 loader 名称进行修改。

Configure according to package-file, there are some img mirror put under the directory of Image in package-file. If the directory doesn't exist, you need to manually create the Image directory and put the needed mirror in the directory. Note that the mirror name must be correct during configuration and bootloader option should change the loader name according to the generated name yourself.

3) 编辑 mkupdate.bat。

Compile mkupdate.bat.

4) 修改 loader 名称为实际存放的 loader 名称。

Change loader name to be the one actually saved.

5) 点击 mkupdate.bat 运行,结束后会在该目录生成一个 update.img。

Click mkupdate.bat to run, and it will generate one update.img in the directory finally.



8.6 固件签名工具 Image signature tool

参考 RKTools\windows\SecureBootTool_v1.83_foruser.rar 中的《Rockchip Secure Boot Application Note》。

Refer to $\langle\!\langle$ Rockchip Secure Boot Application Note $\rangle\!\rangle$ in RKTools\windows\SecureBootTool_v1.83_foruser.rar.

8.7 序列号/Mac/厂商信息烧写-WNpctool 工具 SN/Mac/Vendor information flashing-WNpctool tool

本平台使用 WNpctool 工具进行序列号/Mac/厂商信息的烧写。以下说明该工具的基本用法。

This platform uses WNpctool tool to flash SN/Mac/vendor information. The basic usage of the tool is described as below.

8.7.1 使用 WNpctool 写入 Use WNpctool to write

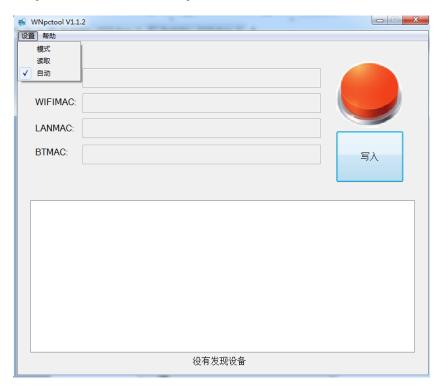


图 8-4WNpctool 工具

Picture 8-4 WNpctool tool

1) 进入 loader 模式。

Enter loader mode.

2) 点击"设置"菜单,下拉框中取消勾选"读取"。



Click "setting" menu, and deselect "Read" in the drop-down box.

(勾选"读取"进行读取,未勾选"读取"则切换到写入功能)

(Select "Read" means to read, and deselect "Read" will convert to write function)

3) 点击"设置"菜单,点击"模式",弹出"模式"窗口,用来设置 SN/WIFI/LAN/BT。
Click "setting" menu, click "mode", pop out "mode" window to set
SN/WIFI/LAN/BT.

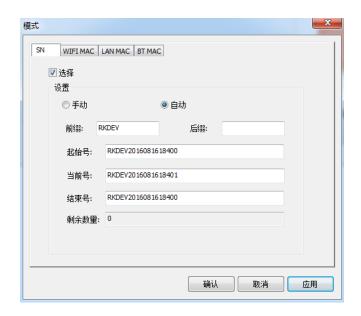


图 8-5WNpctool 工具模式设置

Picture 8-5 WNpctool tool mode setting

- 4) 设置完成后,点击"应用"按钮,关闭模式设置窗口,返回主窗口。
 After setting, click "application" button, close mode setting window and back to the main window.
- 5) 点击 "写入"按钮即可。 Click "Write" button.

8.7.2 使用 WNpctool 读取 Use WNpctool to read

1) 进入 loader 模式。

Enter loader mode.

2) 点击"设置"菜单,下拉框中勾选"读取"。

Click "setting" menu, and select "Read" in the drop-down box.



(勾选"读取"进行读取,未勾选"读取"则切换到写入功能)

(Select "Read" means to read, and deselect "Read" will convert to write function)

3) 点击"读取"按钮即可。

Click "Read" button.

8.8 量产工具使用 Production tool usage

8.8.1 工具下载步骤 Tool download steps

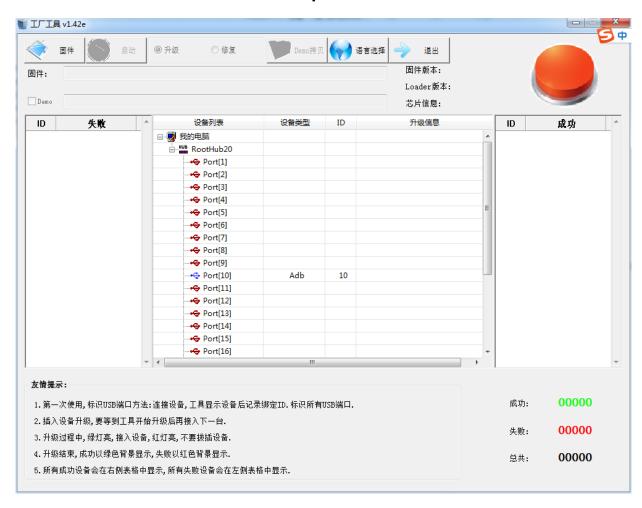


图 8-6 量产工具

Picture 8-8 Production tool

1)点击固件按钮,选择打包工具打包后的 update.img,等待解包成功。

Click image button, select the update.img packed by the package tool, and then wait for unpackage done.

2) 连接设备,并让设备进入 loader 或者 maskrom 模式,工具会自动进行下载。



Connect the device, make it enter loader or maskrom mode, and the tool will start to download automatically.

3) 可同时连接多台设备,进行一拖多烧写,提高工厂烧写效率。

It is able to connect multiple devices to do the flashing at the same time in order to improve the factory flashing efficiency.